

ABSTRACT OF THE DISCLOSURE

In an electronic circuit device having such a structure that a plurality of circuit boards are stacked, when the circuit boards are stacked, one ends of metal pieces serving as spacers are joined to one circuit board by solder while the other ends of the metal pieces are joined to the other circuit by conductive adhesive agent, whereby the circuit boards can be easily separated from each other at the connection portion and a rework of the parts sandwiched between the circuit boards can be easily performed.